



# MECHANICAL ENGINEERING SYMPOSIUM 2024

21 SEPTEMBER 2024 (9.00AM - 5.30PM)

Exhibition Hall 7B (Level 3), Kuala Lumpur Convention Centre

BUILDING SERVICES SOLUTIONS: SUSTAINING FUTURES, & EMBRACING ESG



SCAN FOR REGISTRATION

## Registration Fees

IEM/ASSOCIATION MEMBER – RM 250 (HRD Corp RM 300)  
STUDENT/GRADUATE MEMBER – RM 150 (HRD Corp RM 200)  
NON-MEMBER – RM 350 (HRD Corp RM 400)



Organised by



Held currently with



6 CPD  
IEM24/HQ/289/S



CCD Applied



CPD Applied

# TENTATIVE PROGRAMME

TIME	ACTIVITY
8.00 am	Guest Arrival & Registration
9.00 am	<b>Opening Ceremony</b> Opening Address by Organising Chairman, Ir. Ts. Tony Cheng Yew Leong Welcome Address by METD Chairman, Ir. Dr. Aidil Chee Tahir Keynote Address by IEM President, Prof. Ir. Dr. Jeffrey Chiang
9.30 am	<b>Speaker 1 – “Beyond Green: Transformative Innovations For Sustainable Mall”</b> Jessica Jong - Head of Sustainability & Quality Assurance Sunway Malls
10.00 am	Networking / Coffee Break
10.30 am	<b>Speaker 2 - “Unlocking the Future: Revolutionize Your Building Management”</b> Lee Jong Chin - Life Cycle & Digital Solutions Leader, Carrier Malaysia
11.00 am	<b>Speaker 3 – “How performance-based FLS design approach could contribute to ESG goal in ever-changing built environment?”</b> Poontrika Walton - SEA Project Lead (NFPA-CFPS), Fusion Fire Safety
11.30 am	<b>Speaker 4 – “Considerations for Choosing a Sustainable Air Filtration Solution”</b> KC Lee - Senior Product Manager, APAC Camfil Malaysia Sdn Bhd
12.00 pm	Q&A / Presentation token of appreciation to speakers
12.15 pm	Lunch Break (Included) / Engineer 2024 Exhibition
14.00 pm	<b>Speaker 5 – “Capturing The Future, Rainwater Harvesting For Sustainable Buildings Towards ESG”</b> Dr. Chee Chung Yee - Technical Director, BACFREE Group Malaysia
14.30 pm	<b>Speaker 6 – “Energy, Rental, Operation &amp; Bottomline: Strategies for Sustainable and Profitable Business Management”</b> Ir. Lum Youk Lee - Vice President 2 -2024/2026, Malaysia Shopping Mall Association
15.00 pm	Afternoon Coffee Break
15.30 pm	<b>Speaker 7 – “MEP coordination for a Green Data Centre while maintaining the tier design integrity”</b> Ir. Ts. Siow Jat Shern - Managing Director, Alliance MEP Sdn Bhd
16.00 pm	<b>Speaker 8 – “Preserve Today, Protect Tomorrow: Enhancing Data Center Fire Safety with Passive Fire Protection in Modern Architecture”</b> John Cha - Regional Technical Manager, Promat Asia
16.30 pm	<b>Speaker 9 - “Future-Proof Your Sustainable Building with Connected Elevators”</b> Yeo Hock Soon - Head of Sales, Service & Modernization, Kone Elevator
17.00 pm	Q&A Presentation token of appreciation to speakers
17.30 pm	<b>Closing- End</b>



# MECHANICAL ENGINEERING SYMPOSIUM 2024

BUILDING SERVICES SOLUTIONS:  
"SUSTAINING FUTURES, & EMBRACING ESG"



Ir. Ts. TONY CHENG YEW LEONG

**ORGANISING CHAIRMAN,**  
**MECHANICAL ENGINEERING SYMPOSIUM 2024**  
SECRETARY, MECHANICAL ENGINEERING TECHNICAL DIVISION, METD  
THE INSTITUTION OF ENGINEERS MALAYSIA

## OUR SPEAKERS



**SPEAKER 1**  
**JESSICA JONG**  
HEAD OF SUSTAINABILITY &  
QUALITY ASSURANCE SUNWAY MALLS,  
MALAYSIA



**SPEAKER 2**  
**LEE JONG CHIN**  
LIFE CYCLE & DIGITAL SOLUTIONS LEADER,  
CARRIER MALAYSIA



**SPEAKER 3**  
**POONTRIKA WALTON**  
SEA Project Lead (NFPA-CFPS),  
Fusion Fire Safety



SCAN FOR SPEAKER BIODATA



**SPEAKER 4**  
**KC LEE**  
Senior Product Manager,  
APAC Camfil Malaysia Sdn Bhd



**SPEAKER 5**  
**Dr CHEE CHUNG YEE**  
TECHNICAL DIRECTOR  
BACFREE GROUP MALAYSIA



**SPEAKER 6**  
**Ir. LUM YOUK LEE**  
VICE PRESIDENT 2 -2024/2026,  
MALAYSIA SHOPPING MALL ASSOCIATION



**SPEAKER 7**  
**Ir. Ts. SIOW JAT SHERN**  
MANAGING DIRECTOR,  
ALLIANCE MEP SDN BHD



**SPEAKER 8**  
**JOHN CHA**  
REGIONAL TECHNICAL MANAGER,  
PRMAT ASIA



**SPEAKER 9**  
**YEO HOCK SOON**  
HEAD OF SERVICE & MODERNIZATION  
KONE ELEVATOR



**Ir. Ts. Dr. SARA LEE KIT YEE**  
**MODERATOR**  
COMMITTEE MEMBER, METD  
THE INSTITUTION OF ENGINEERS MALAYSIA

# SPONSORSHIP PACKAGE

No	Type of Sponsor	Gold	Silver	Bronze
	<b>Sponsorship Package Value</b>	<b>RM 20,000</b>	<b>RM 15,000</b>	<b>RM 10,000</b>
1	Company corporate logo will be displayed throughout the symposium & exhibition promotional flyers & advertisement	✓	✓	✓
2	Corporate promotional material to be inserted in goodie bags	✓		
3	Company corporate logo will be printed on the back cover page of programme booklet	✓	✓	✓
4	One (1) full coloured A4 size advertisement in the programme book	✓		
5	Complimentary conference passes	5	2	1

1. The event is Organised by Mechanical Engineering Technical Division, IEM.
2. The Symposium will be held on the 18th - 21st September 2024 at Kuala Lumpur Convention Centre, Kuala Lumpur, Malaysia.
3. By signing the contract of sponsorship, the Sponsor is deemed to have agreed / given permission to the following:
  - a) Logo submission for the purpose of marketing and advertising of the symposium & exhibition.
  - b) The Organiser reserves the right to place the logo in any of the marketing collaterals across various platforms (print, digital, outdoor).
  - c) The Sponsors will need to submit the required logo and artwork for any of the marketing collaterals usage not later than 1<sup>st</sup> August 2024, in the event that this submission is not made on time, the logo and advertisement may not be placed. Thank you for your cooperation.
  - d) The Organiser reserves the right to change the date and/or venue or to postpone the summit due to force majeure at its sole discretion.

It is our pleasure to inform that we would like to sponsor MECHANICAL ENGINEERING SYMPOSIUM 2024 for a Sponsorship Package Value \_\_\_\_\_ (Gold/Silver/Bronze) and enclose herewith Banker's Cheque / Local Cheque No.: \_\_\_\_\_ issued to 'The Institution of Engineers, Malaysia' for the sum of Ringgit Malaysia \_\_\_\_\_.

Attention to: MECHANICAL ENGINEERING SYMPOSIUM 2024. Email: [roselein@iem.org.my](mailto:roselein@iem.org.my) & cc: [tonychengyl@gmail.com](mailto:tonychengyl@gmail.com)

Yours faithfully,

\_\_\_\_\_

Contact Name :

Organization :

Contact number :

E-mail address :

Company Stamp: